

PATENT WITHDRAWAL NOTICE

DATE WITHDRAWN

4/17/09

WITHDRAWAL NUMBER

17124

The following application has been **WITHDRAWN** from the

Tuesday, May 05, 2009 issue.

SERIAL NO.

10/591,455

PATENT NUMBER

7,528,193

DRAWINGS

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CLASS

525/064

TITLE

THERMOPLASTIC RESIN COMPOSITION AND MOLDED ARTICLE COMPRISING THE SAME

NAME AND ADDRESS

HIDEO AOKI, ET AL
KAWASAKI-SHI , JPX

REASON FOR WITHDRAWAL

Office of Petitions granted applicant's request to withdraw patent from issue.

APPROVED

/Kimberly Terrell/, Manager
Patent Publication Branch
Office of Data Management